



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: Wongsenakhum et al.

Attorney Docket No.:

NOVLP096/NVLS-2902

Application No.: 10/815,560

Examiner: Estrada, Michelle.

Filed: March 31, 2004

Group: 2823

Title: METHOD OF FORMING LOW-  
RESISTIVITY TUNGSTEN  
INTERCONNECTS

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as first-class mail on February 15, 2006 in an envelope addressed to the Commissioner for Patents, Mail Stop RCE, P.O. Box 1450 Alexandria, VA 22313-1450.

Signed: \_\_\_\_\_

Tara Hayden

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AMENDMENT FILED WITH RCE**

Dear Sir:

This amendment is in response to the Final Office Action mailed on December 28, 2005 in the above-identified application and accompanies a Request for Continued Examination.

Amendments to the Claims are reflected in the Listing of Claims that begins on page 2 of this paper.

Remarks begin on page 6 of this paper.

*Entered  
w/ RCE  
2/24/06  
yk*